

JAMS

Identification and Validation of Analytical Chemistry Methods for Detecting Composite Surface Contamination and Moisture

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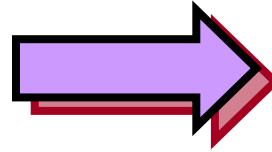


FAA Sponsored Project Information

- PI & Researchers
 - Dwayne McDaniel, Richard Burton, Weihua Zhang, Wongbon Choi, Xiangyang Zhou
- Students
 - Yao Ge, Ling Wang, Tomas Pribanic, Kevin LaMott
- FAA Technical Monitor
 - Curtis Davies
- Industry Participation
 - Exponent, DME, Avborne, AeroMatrix

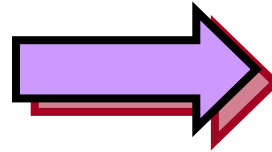
- **Motivation and Key Issues**
 - Adhesive bonding is now used in manufacture and repair is beginning to predominate over mechanical fastening.
 - Adherent surface preparation is a critical issue to the structural integrity and durability of bonded structures.
- **Objective**
 - benchmark knowledge of surface preparation quality assurance methods
 - Identify, evaluate, and validate definitive analytical chemistry methods to provide sufficient in-field quality assurance.
- **Approach**
 - Literature review and analysis (completed)
 - Surface chemistry analysis
 - Electrochemical sensor evaluation
 - Experimental validation

Information collection and
 analyses

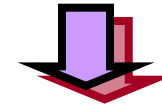


Strength & durability
 versus surface
 pretreatment

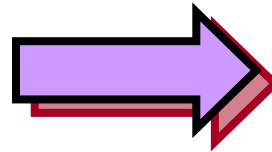
Information collection and
 analyses



Surface analysis
 methods

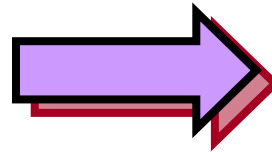


Technology evaluation



Candidate field analysis
 technologies

Technology validation



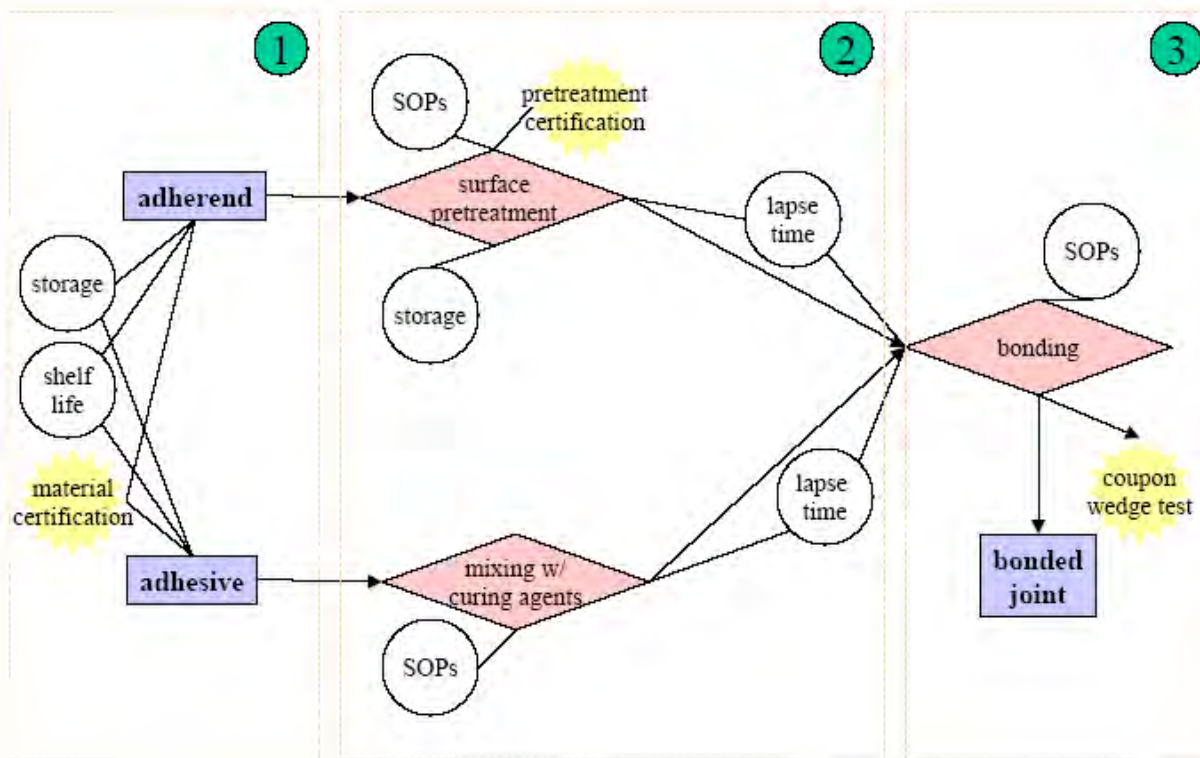
Effective field analysis
 technology

- Literature database, completed
- Summary of literature review
 - Surface treatment, completed
 - Surface chemistry analyses, completed
- Proposed and evaluated electrochemical sensor for surface chemistry analysis.
- Proposed and evaluated carbon nano-tube sensor for humidity sensing.
- AFM/SEM study of surface-contamination (peel-ply, etc).

- Evaluation of alternative mediators for sensor preparation
- Evaluation of both cyclic voltametry and electrochemical impedance spectroscopy methods
- Fabrication and testing of prototype sensors
- AFM force spectroscopy of peel ply samples and statistical analyses
- CFM imaging of the peel ply samples - in progress

Polymer	Treatment	Surface composition (at%)		Failure load/N
		C	O	
HDPE	No treatment	100.0	0.0	400
	2.1 V, Pt edge, 50 passes	95.5	4.5	1330
	2.4 V, Pt edge, 50 passes	96.2	3.8	1320
	2.9 V, Pt disc, 5 min	92.4	7.6	1110
PP	No treatment	100.0	0.0	0
	3.25 M nitric acid, 60 s	—	—	267
	2.1 V, Pt edge, 50 passes	92.6	7.4	2060
	2.4 V, Pt edge, 50 passes	93.1	6.9	2560
	2.9 V, Pt edge, 50 passes (H ₂ SO ₄ ⁻)	100	0	50
	2.9 V, Pt disc, 300 s, not touching	—	—	270
	2.9 v, Pt disc, 300 s, far removed	—	—	390
SBS	No treatment	100.0	0.0	—
	2.5 V, Pt edge, 50 passes	83.6	14.6 ^b	—
PS	No treatment	100.0	0.0	550
	2.9 V, Pt disc, 300 s	94.5	5.5	670

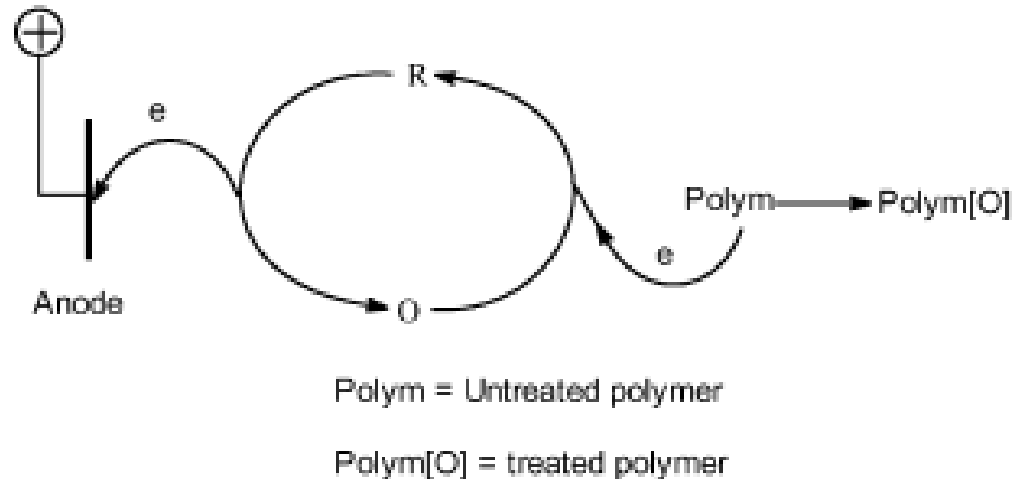
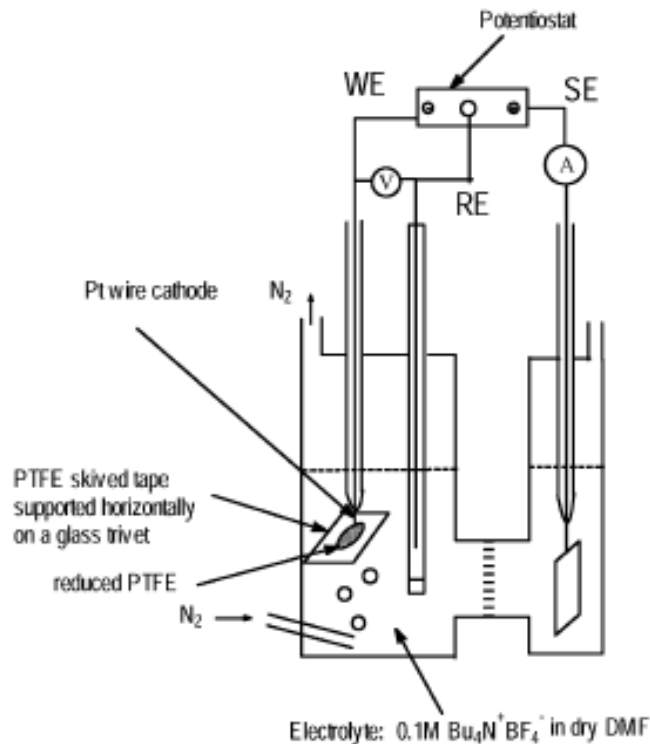
X-ray photoelectron spectroscopy (XPS)
A quantitative analytical chemistry method



- Materials certification
- Pretreatment certification
- Adhesive application certification
- Bonding certification
- Technician certification
- Process flow management

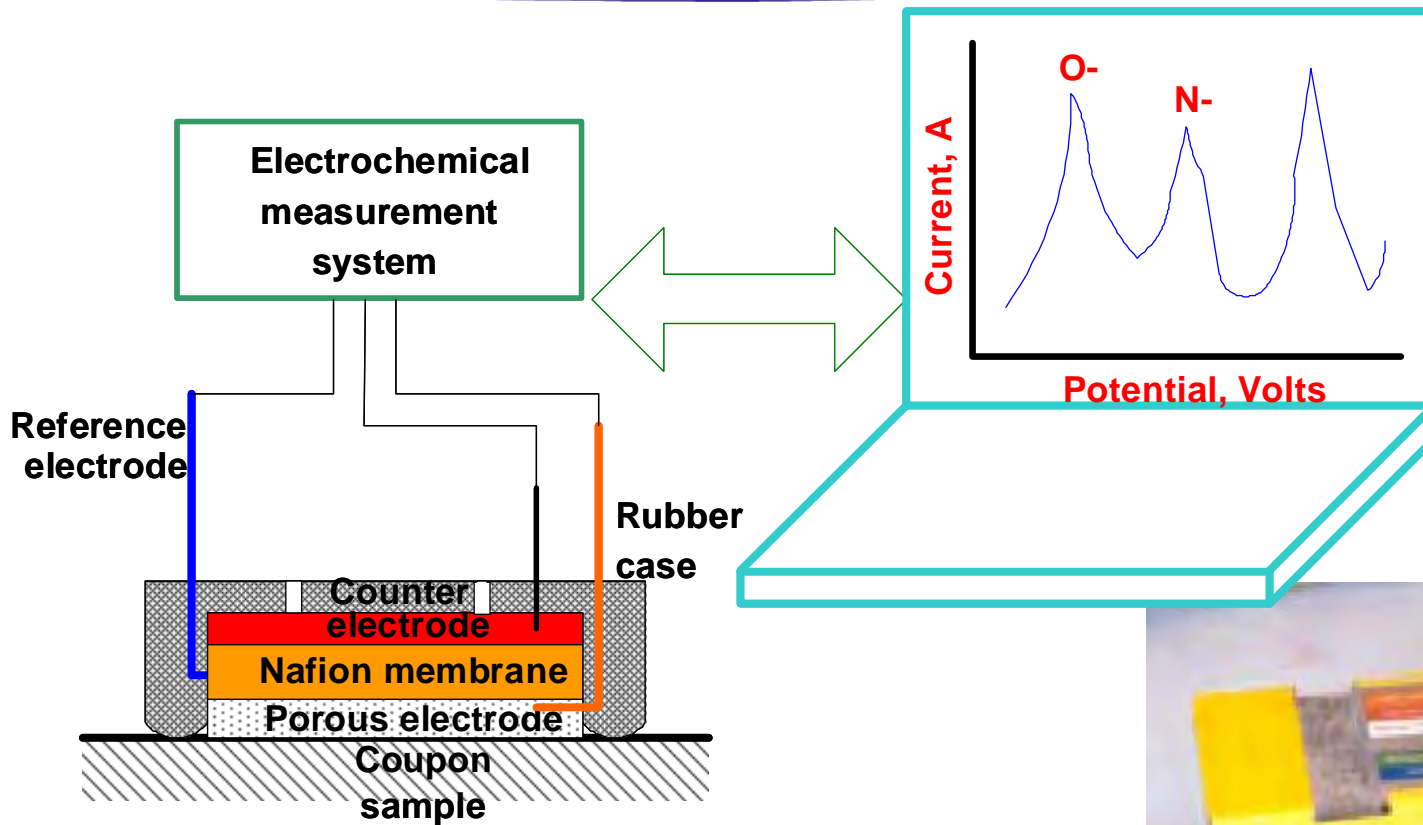
$$N_{adsorbed} < N_{adsorbed} \text{ (critical)}$$

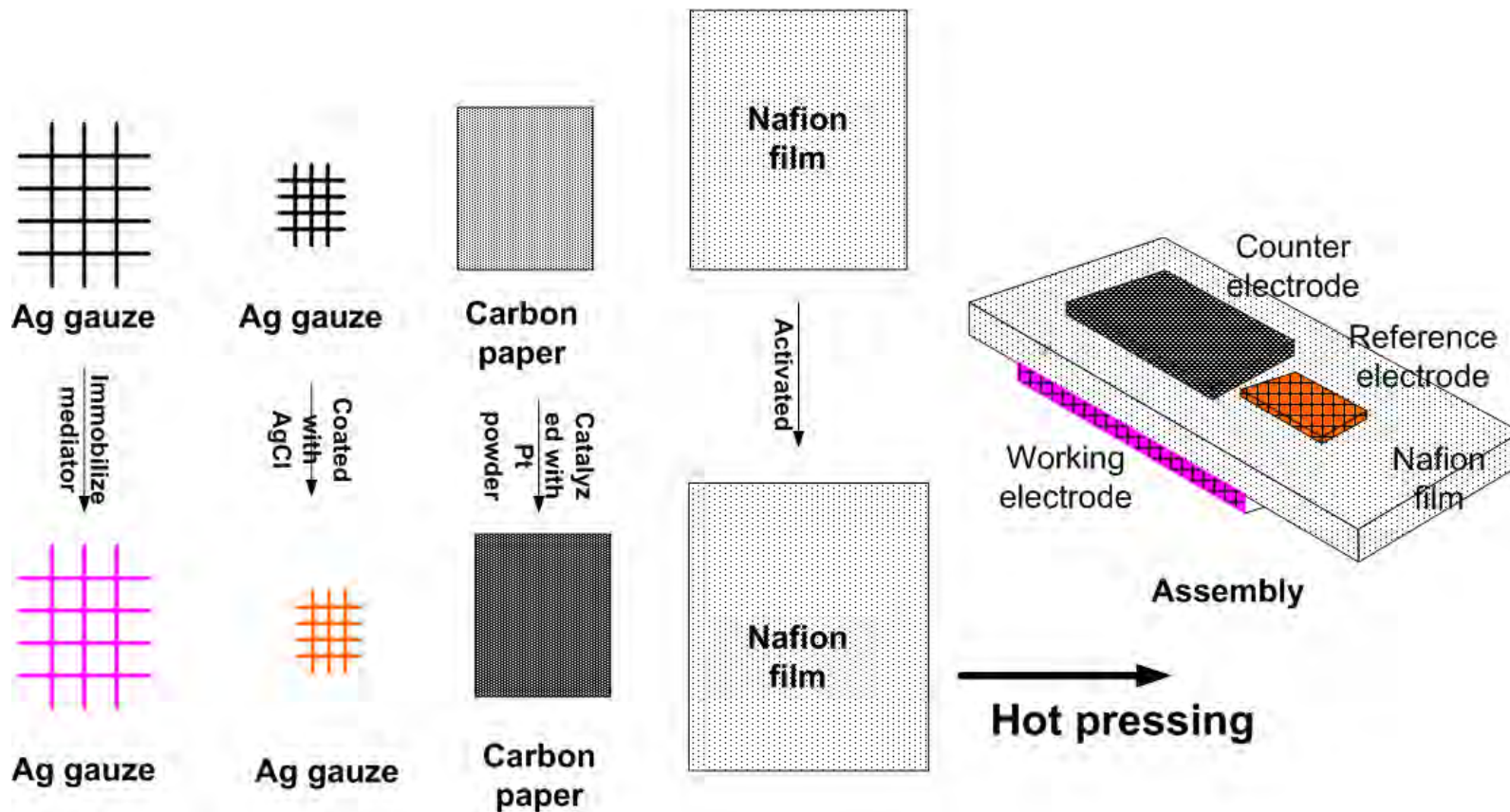
$$N_{O- \& N-} > N_{O- \& N-} \text{ (critical)}$$



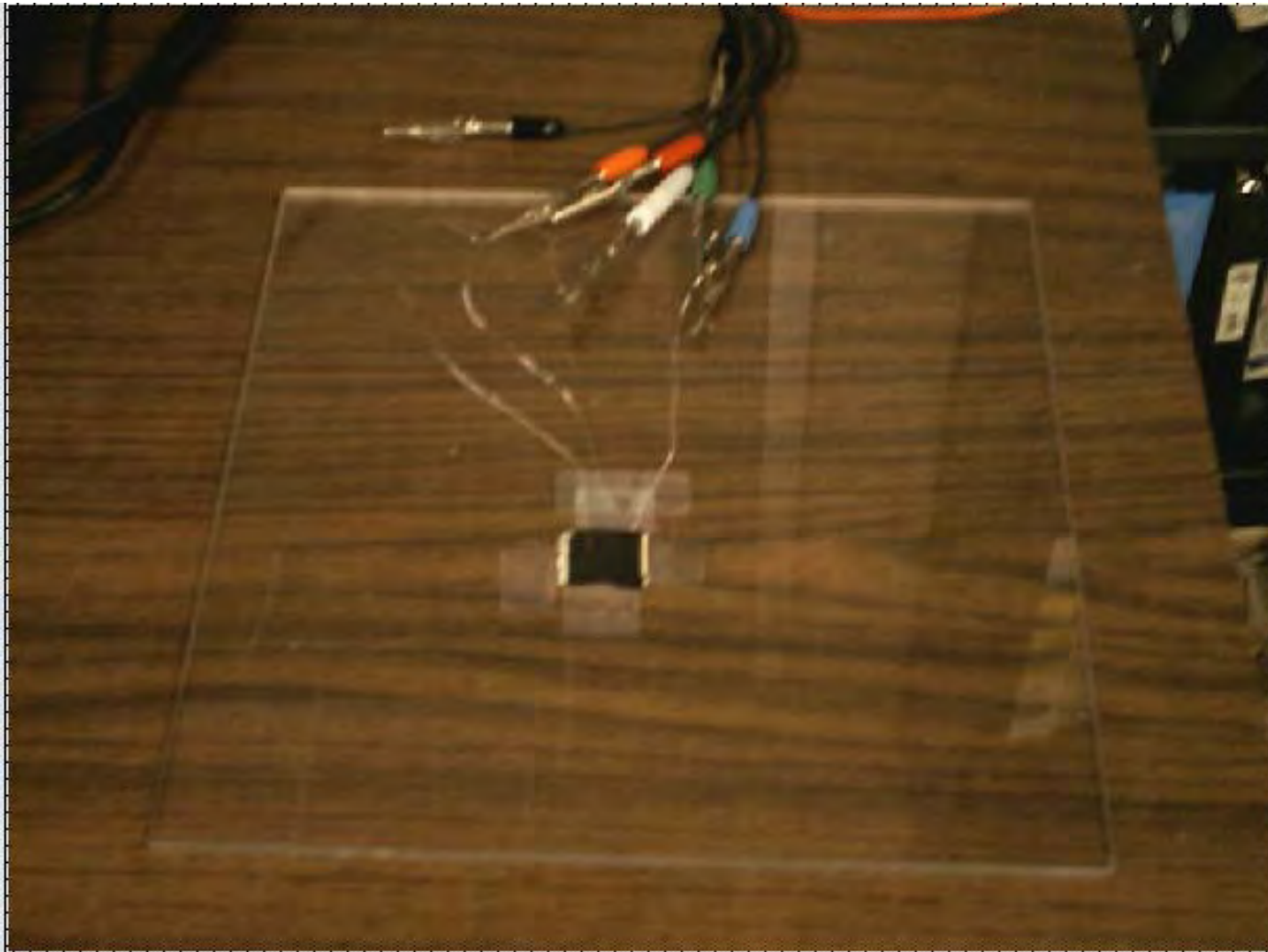
D.M. Brewis, R.H. Dahm | International Journal of Adhesion & Adhesives 21 (2001) 397-409

Solid-State Electrochemical Sensor





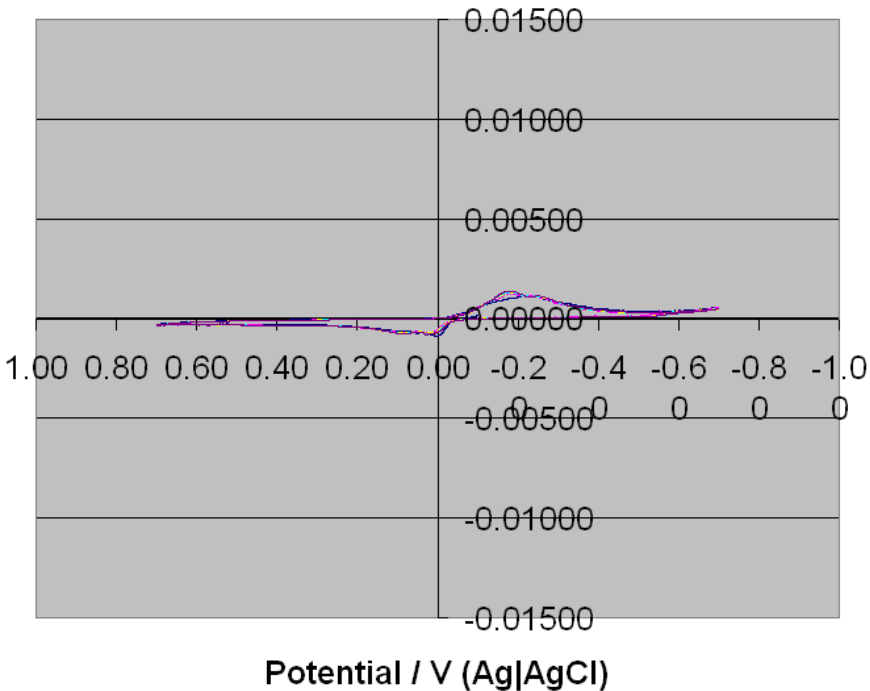
Solid-state Electrochemical Sensor



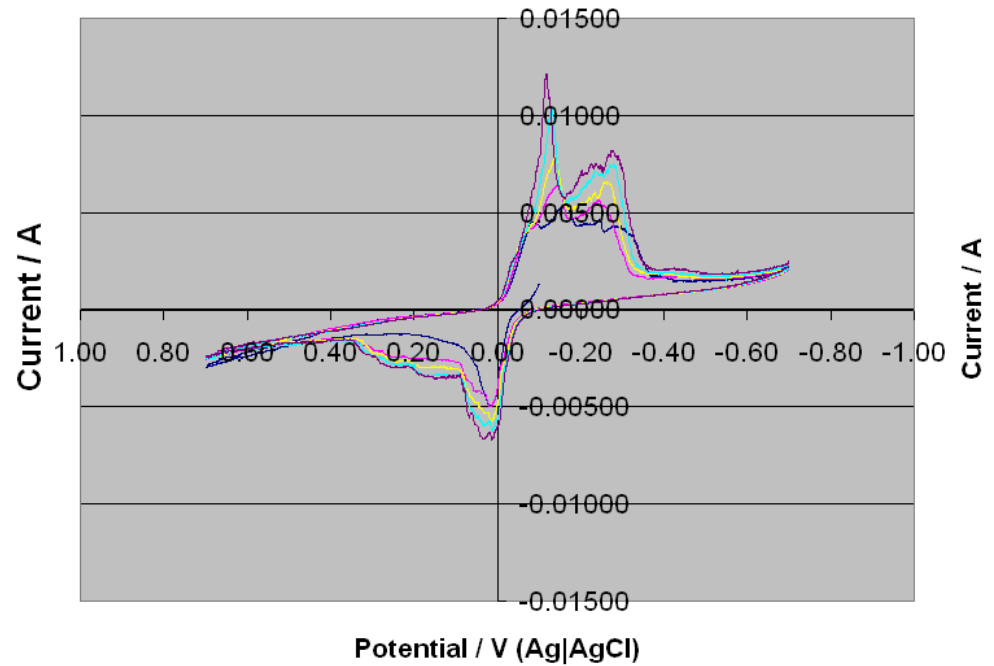
Tests on Polyester Peel Ply Samples

- Original surface: after removing peel ply
- Polished surface: polished using polishing paper (#600), and wiped with paper.
- Sulfuric acid etched: immersed in 50% sulfuric acid for 1-2 seconds, washed with DI water, and dried.

Ag(I)/Ag(II) mediator

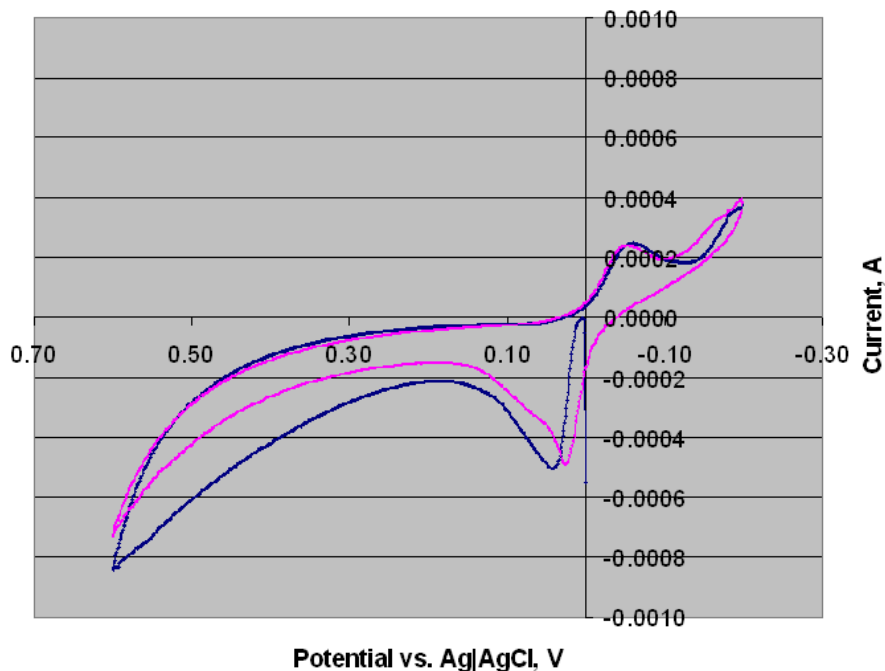


Original surface

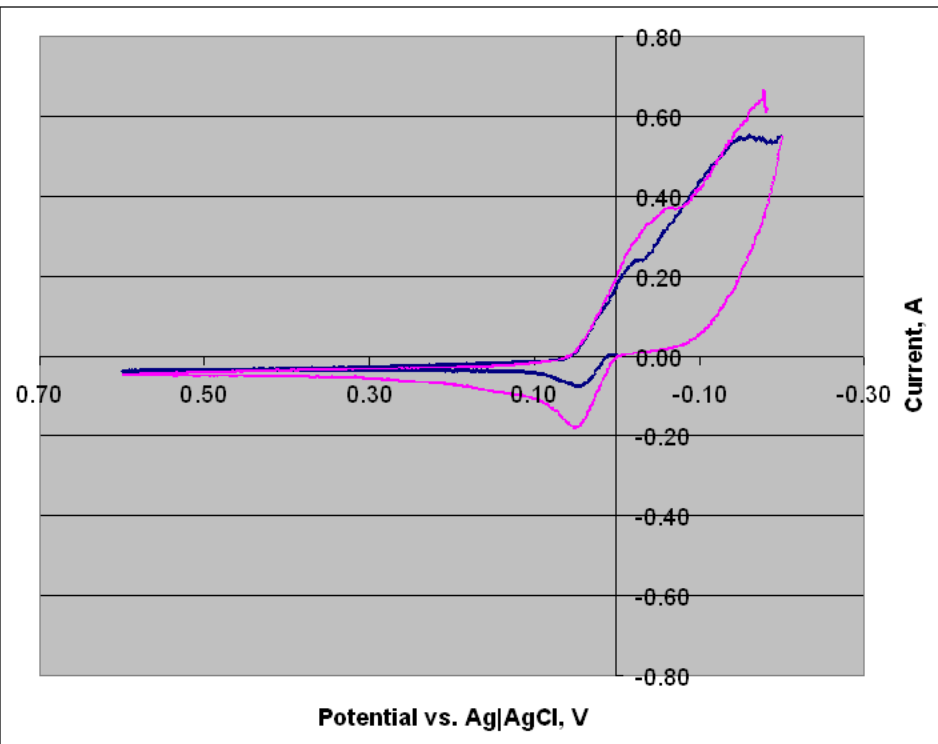


Treated with sulfuric acid

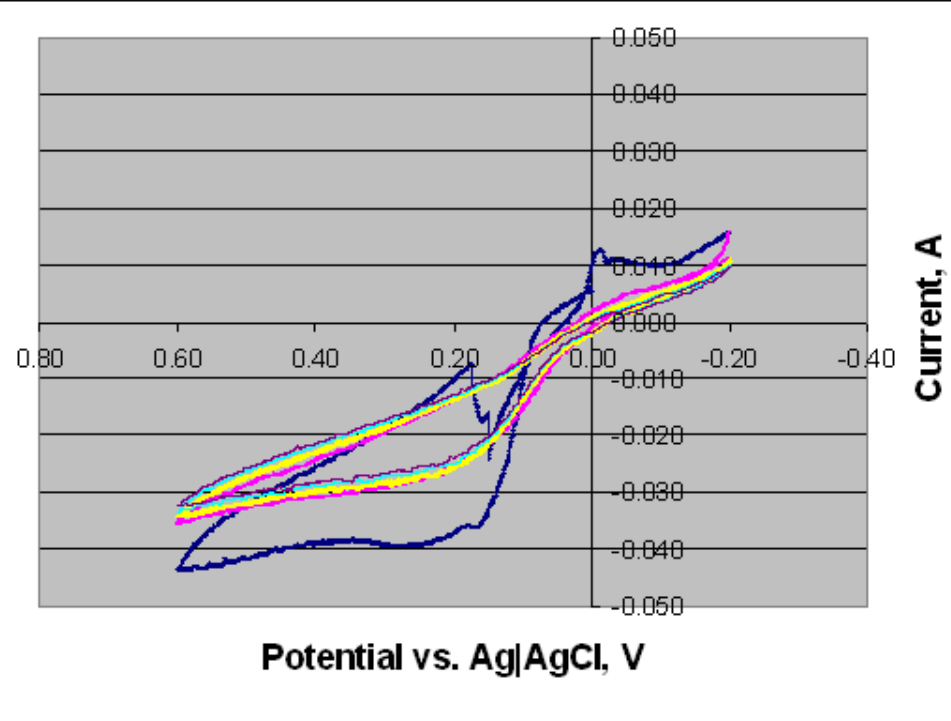
Mn(II)/Mn(III) Mediator



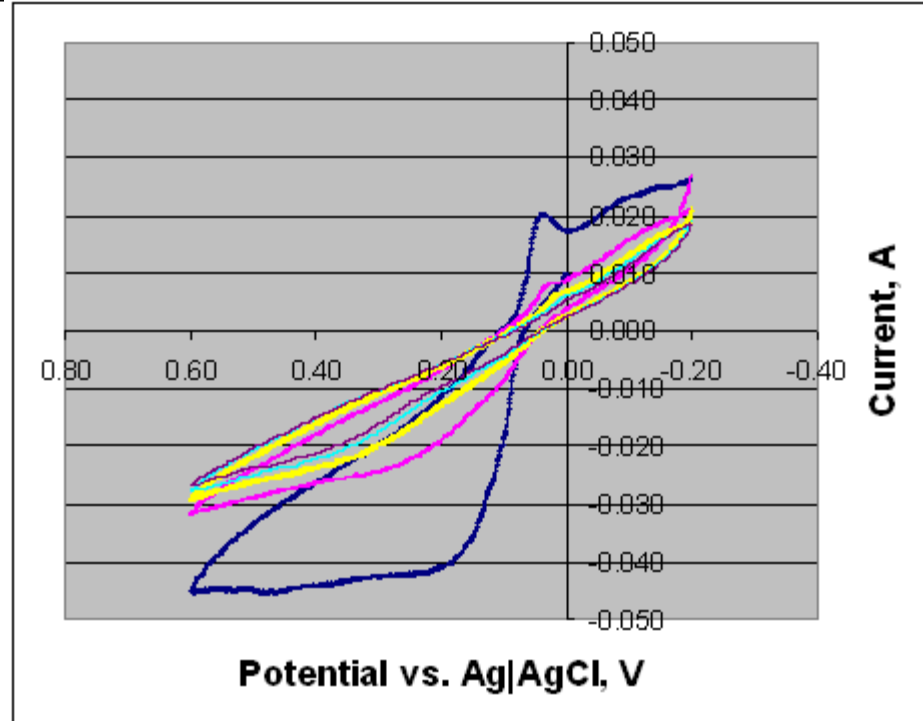
Original sample



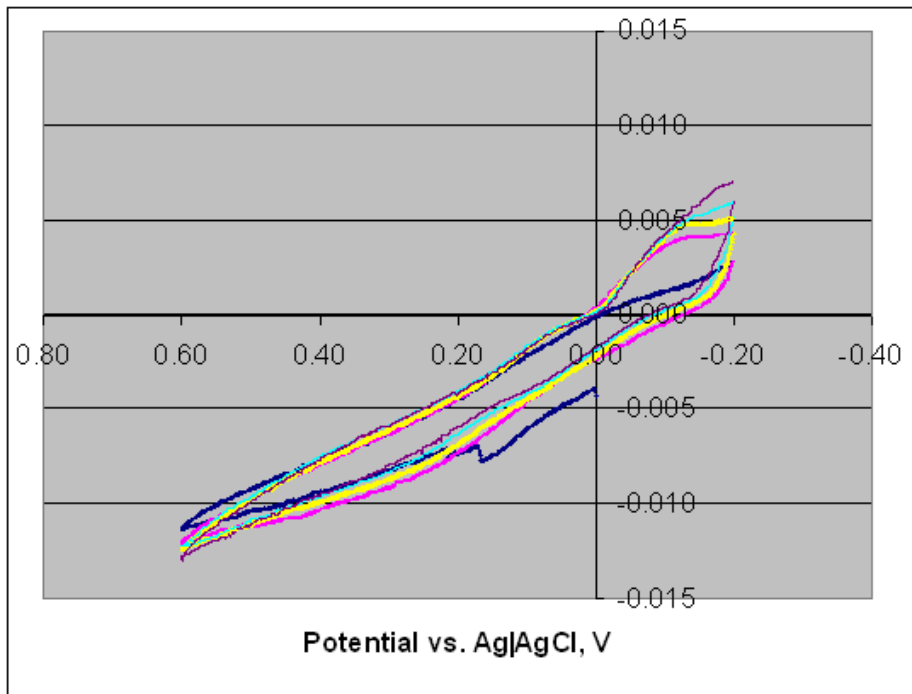
Sulfuric acid treated sample



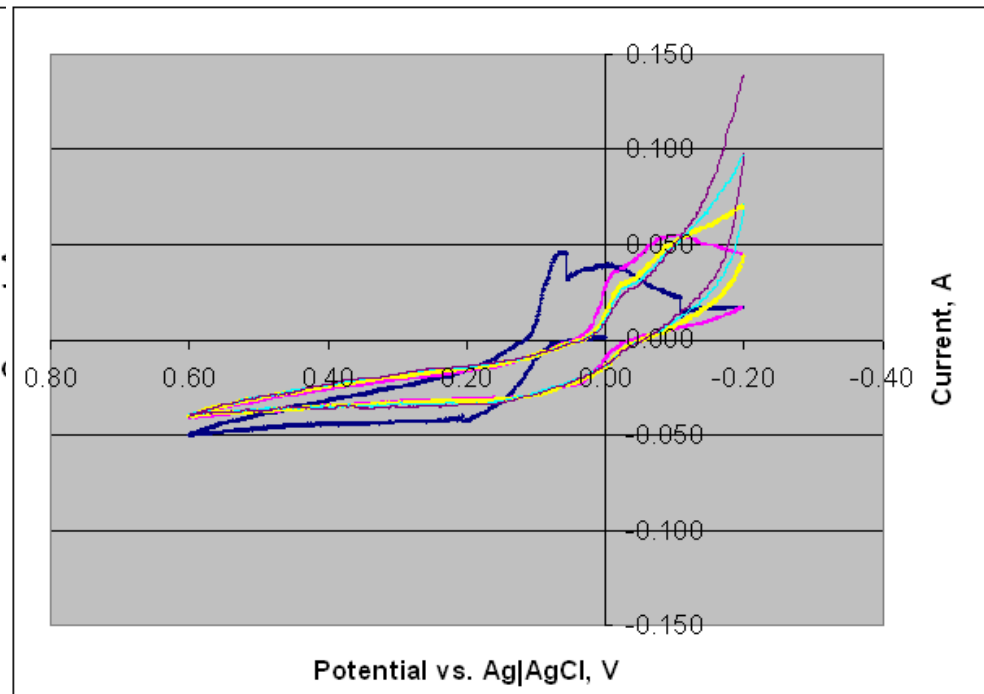
Original sample



Sulfuric acid treated sample



Original sample



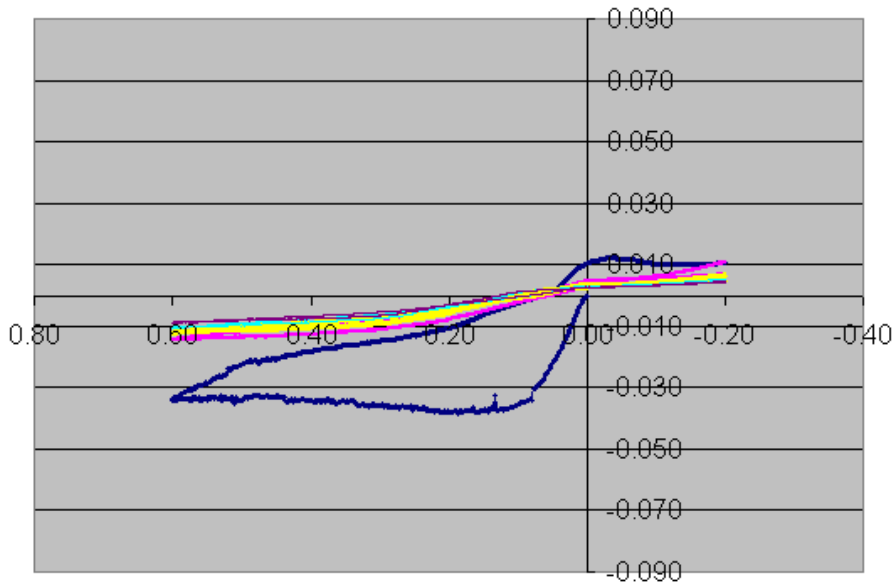
Sulfuric acid treated sample



	$I_{ca} (ori), A$	$I_{an} (ori), A$	$I_{ca} (sul), A$	$I_{an} (sul), A$	$I_{ca} (sul)/I_{ca} (ori)$	$I_{an} (sul)/I_{an} (ori)$
Ag(I)/Ag(II)	0.001	0.0005	0.0125	0.006	12.5	12
Mn(III)/Mn(IV)	0.0004	0.00081	0.65	0.18	1625.0	222.2
Ce(III)/Ce(IV)	0.015	0.042	0.026	0.045	1.733	1.071
Cu(I)/Cu(II)	0.0055	0.0125	0.145	0.05	26.36364	4.0

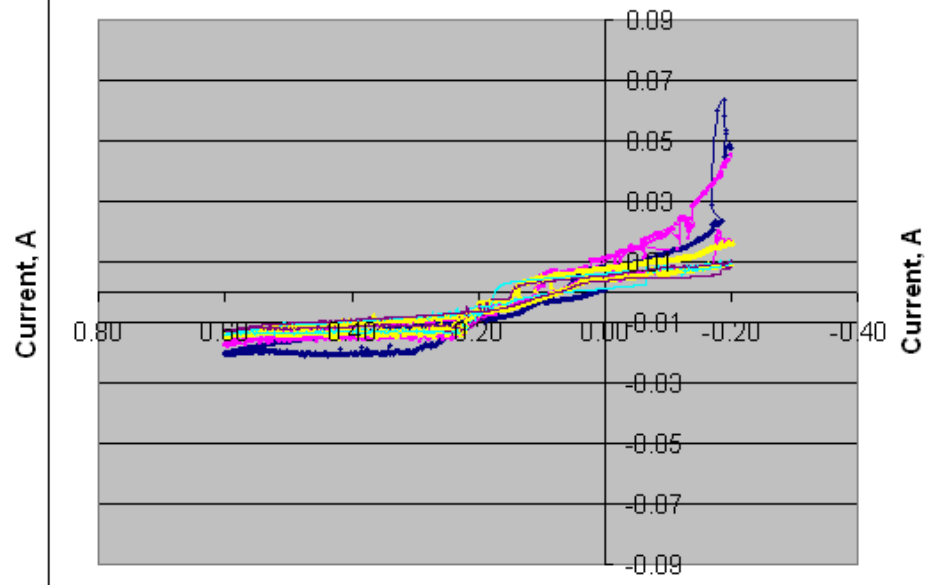
Prototype Sensor





Potential vs. Ag|AgCl, V

Original sample



Potential vs. Ag|AgCl, V

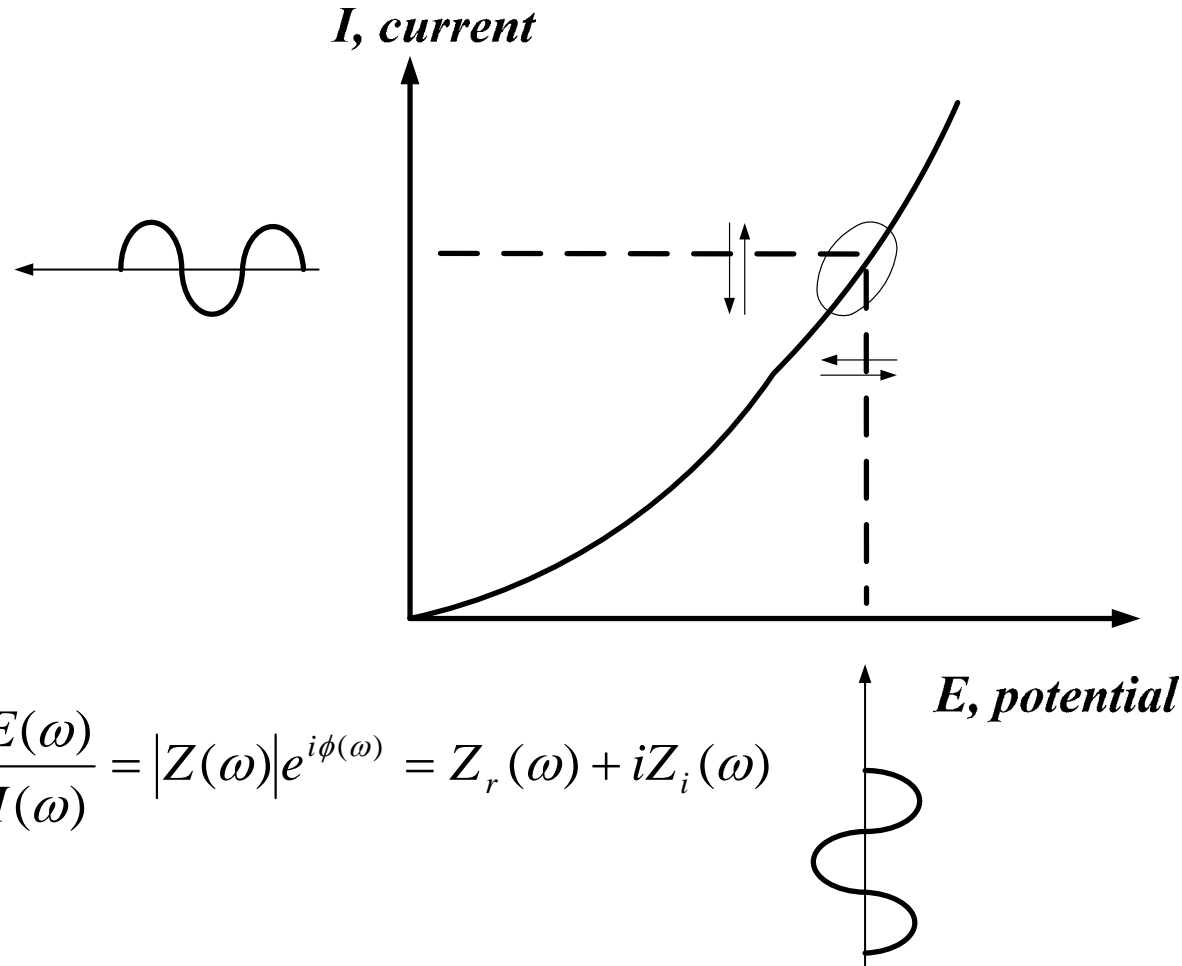
Sulfuric acid treated sample

Treatment with sulfuric acid produces

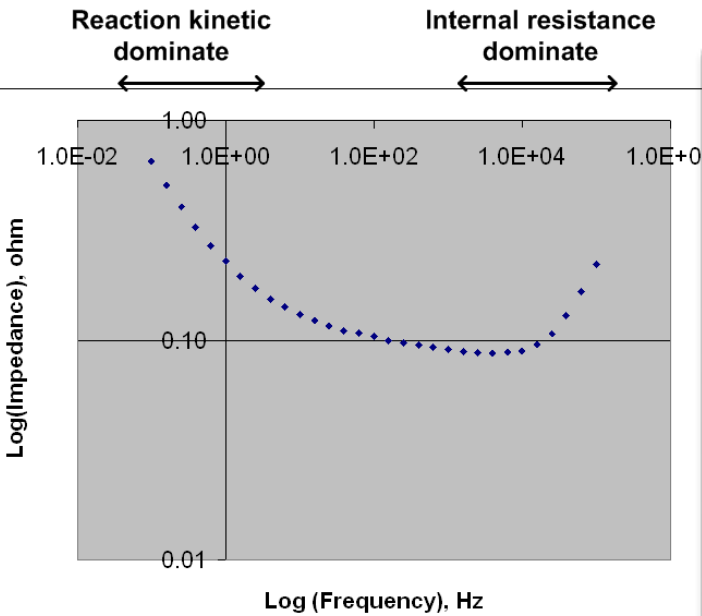
Hydroxyl, carbonyl, carboxylic acid, phenol, and sulfonated groups, ions, or fragments that may be very unstable and can be reduced or oxidized at certain potentials. The surface chemistry can be analyzed using XPS and FTIR.

The electrochemical sensor can detect these groups, ions, or fragments on the surfaces.

Electrochemical Impedance Spectroscopy



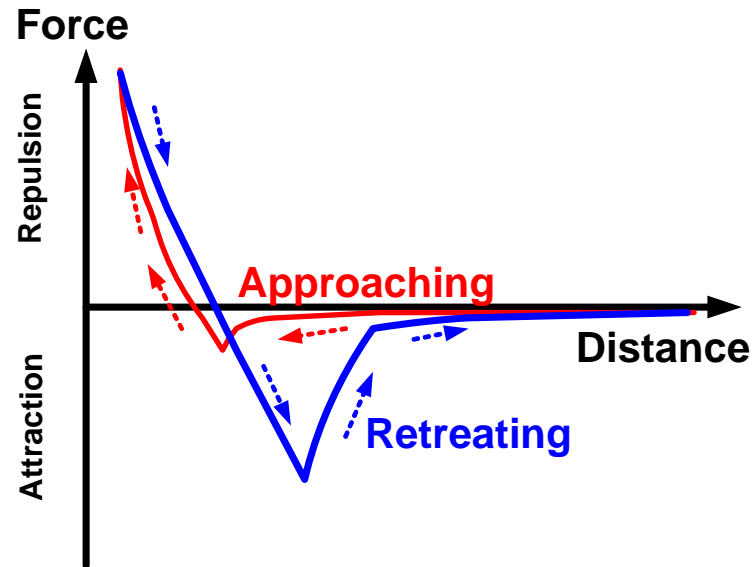
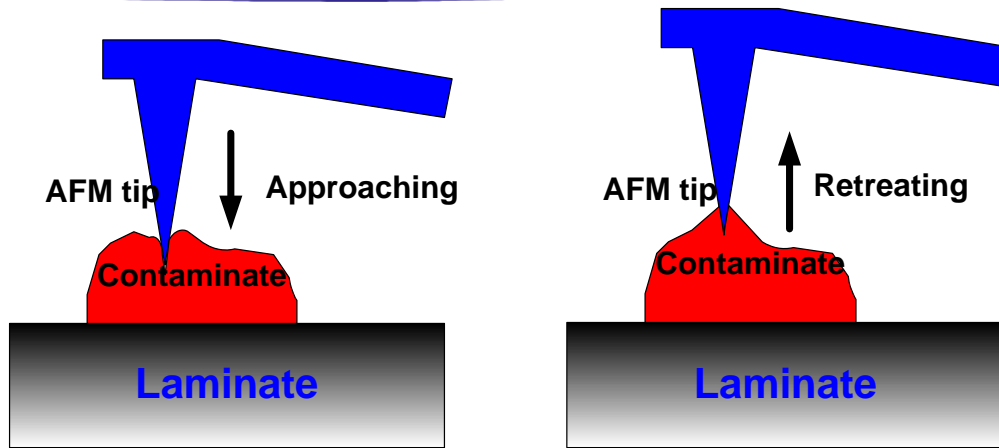
$$Z(\omega) = \frac{E(\omega)}{I(\omega)} = |Z(\omega)|e^{i\phi(\omega)} = Z_r(\omega) + iZ_i(\omega)$$



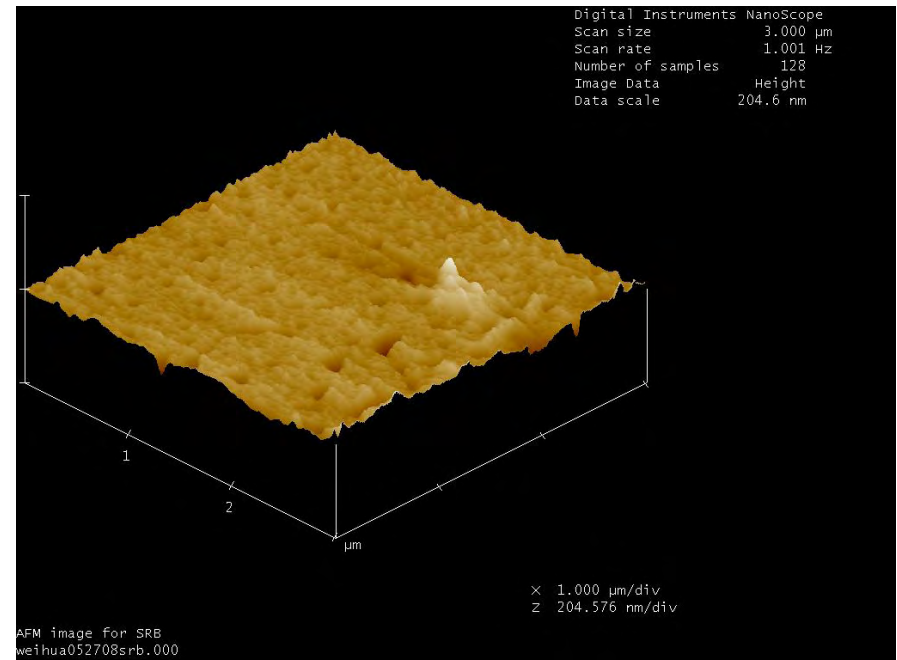
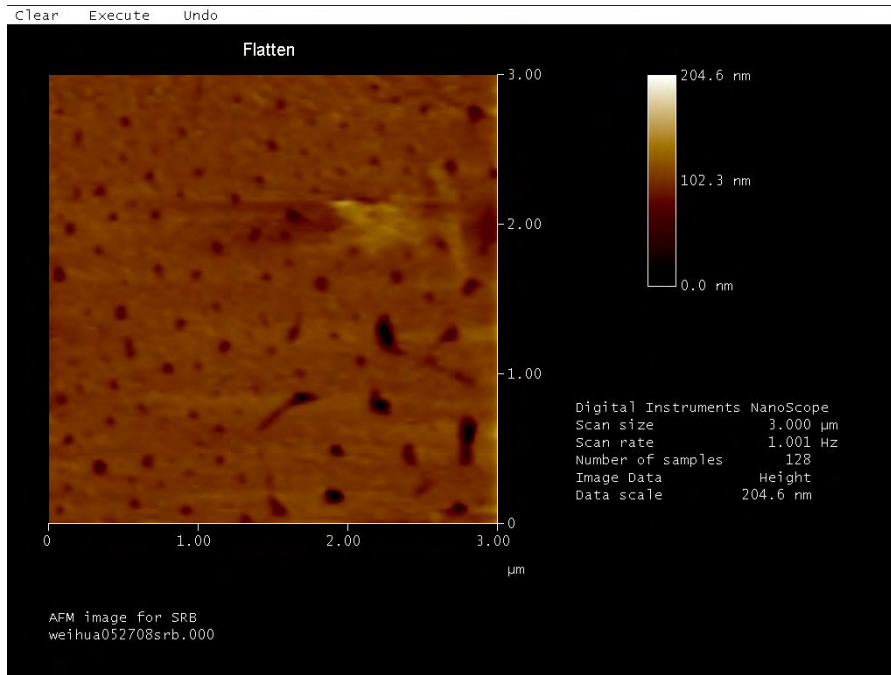
	Imp (Hi), ohm	Imp (Lo), ohm	Imp (Lo)-Imp (Hi) ohm	Ratio (Ori/Sul)
Ag-ori	8.369	6.36x10 ⁴	6.36x10 ⁴	150
Ag-sul	1.34	4.24x10 ²	4.24x10 ²	
Mn-ori	2.81	81.7	78.9	183
Mn-sul	0.221	0.652	0.431	
Ce-ori	2.62	55.6	53.0	2.16
Ce-sul	0.336	24.8	24.5	
Cu-ori	0.199	97.8	97.6	21.7
Cu-sul	0.426	4.93	4.50	
Ce-ori	0.441	1.58	1.139	3.07
Ce-sul	1.14	1.51	0.37	

**Sulfuric acid treated surface
 Sensor with Mn(II)/Mn(III)
 mediator**

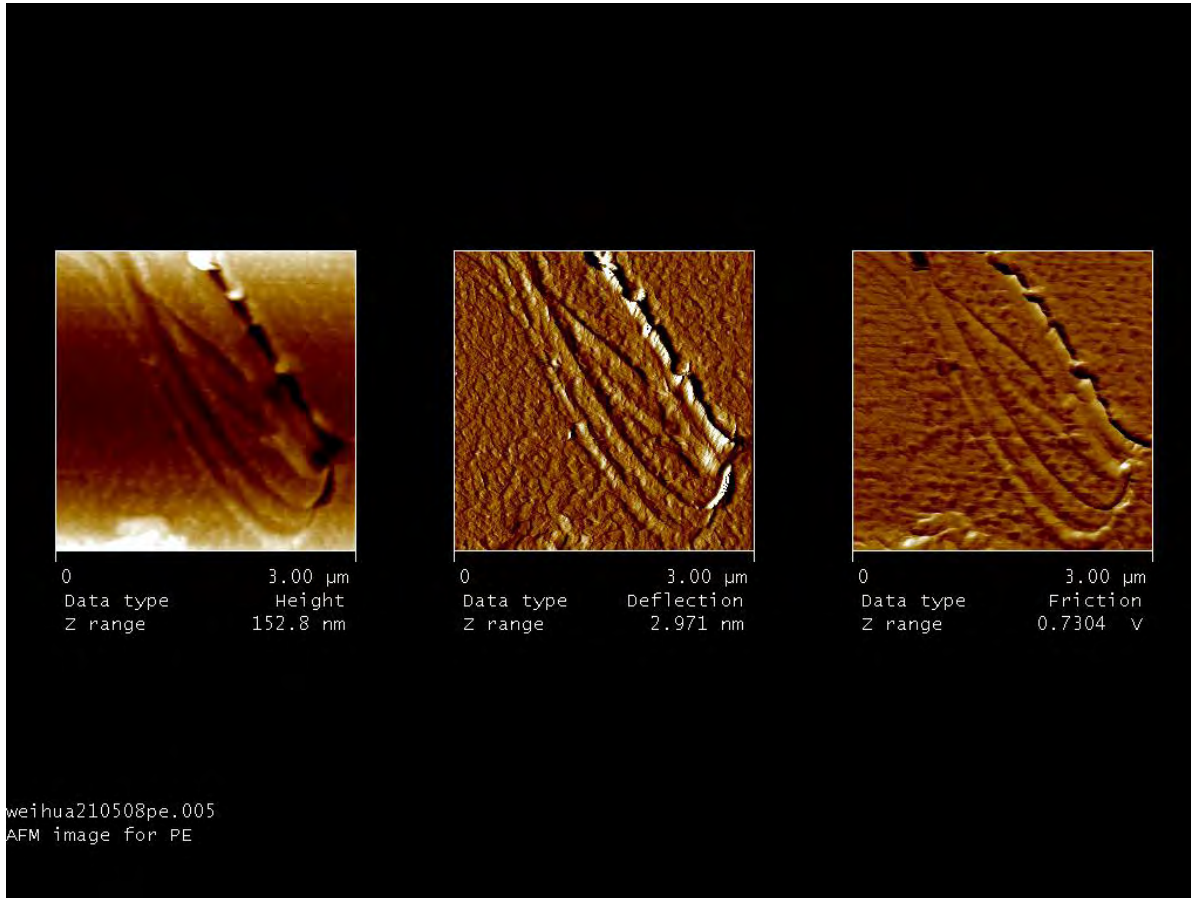
AFM Force Spectroscopy

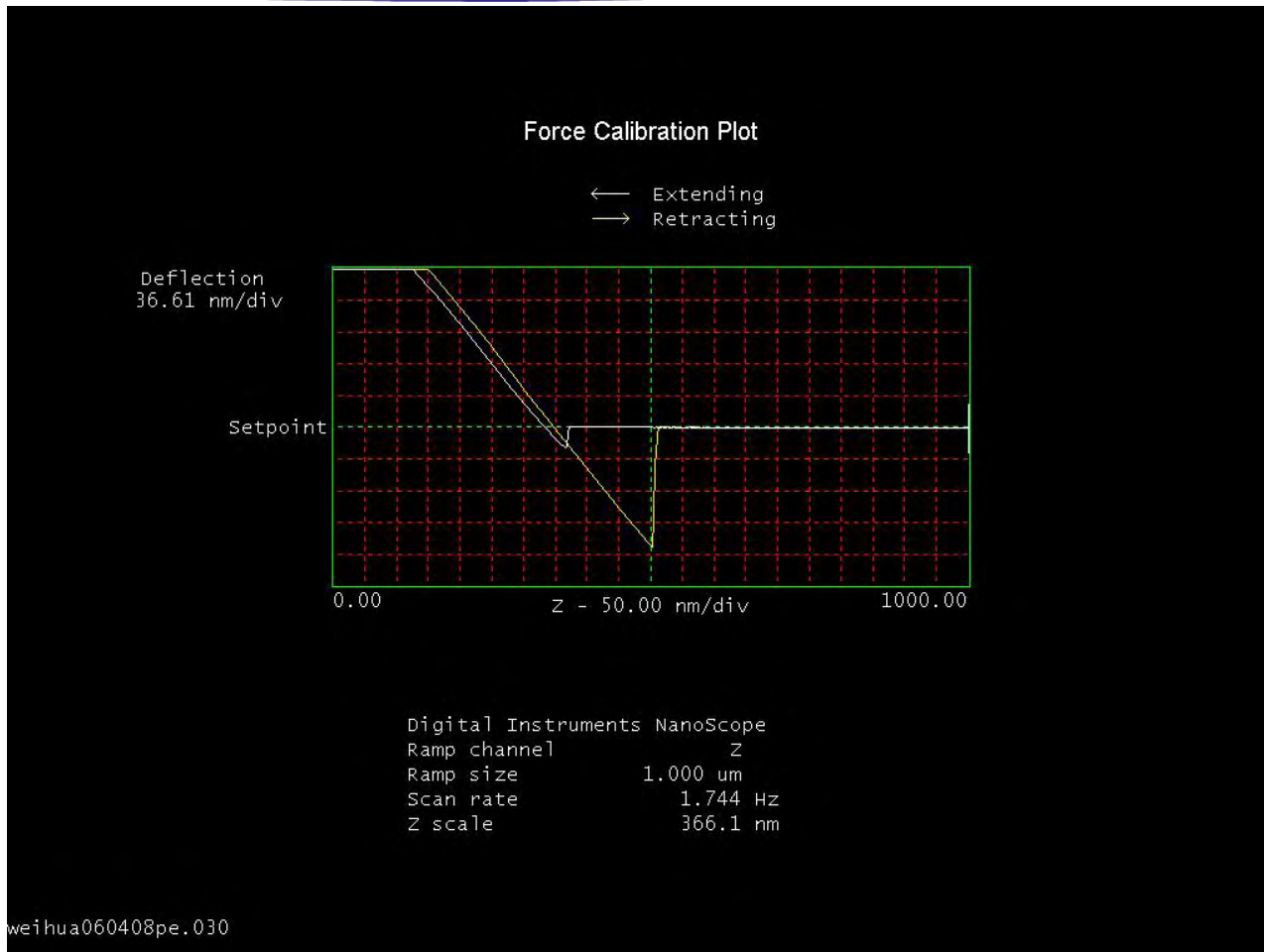


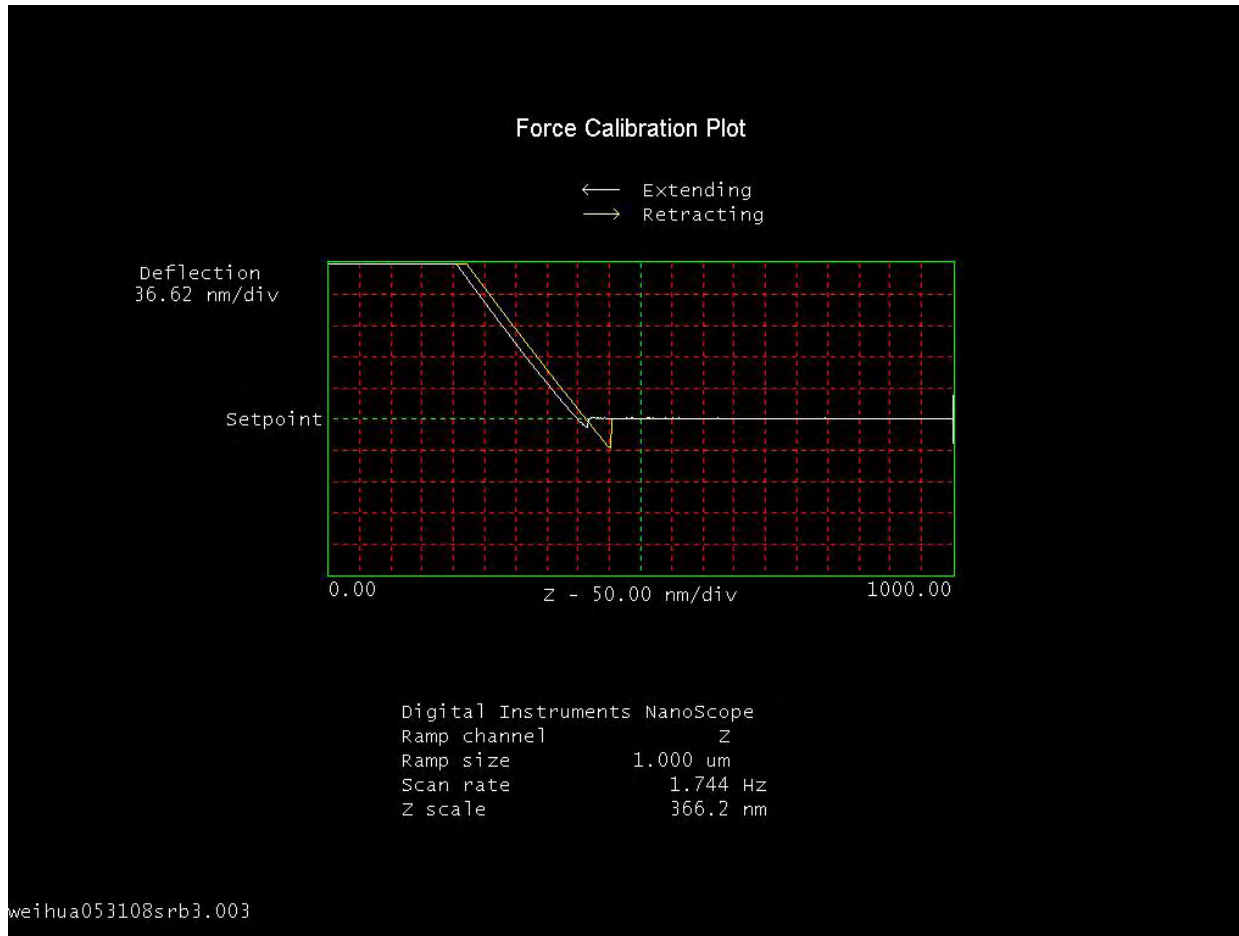
AFM Images of SRB Prepared Laminate Surfaces



AFM Images of PE Prepared Laminate Surfaces

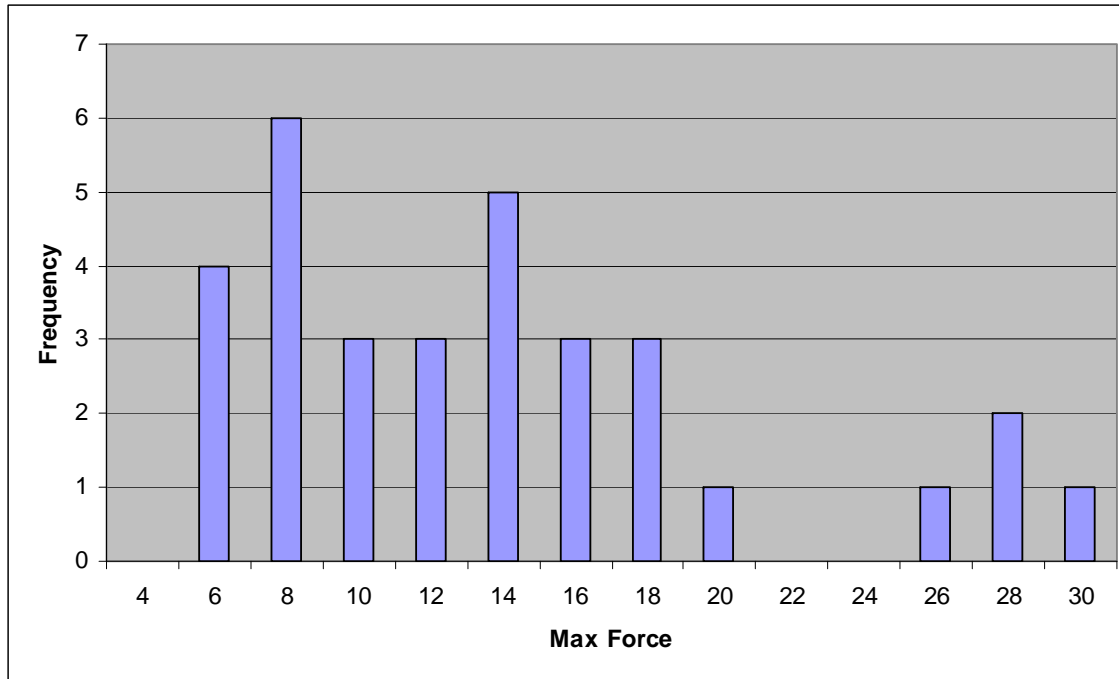






Force Spectroscopy Statistics

PE Prepared Surfaces



Average Force: 11.4 nN

Std. Deviation: 7.5 nN**

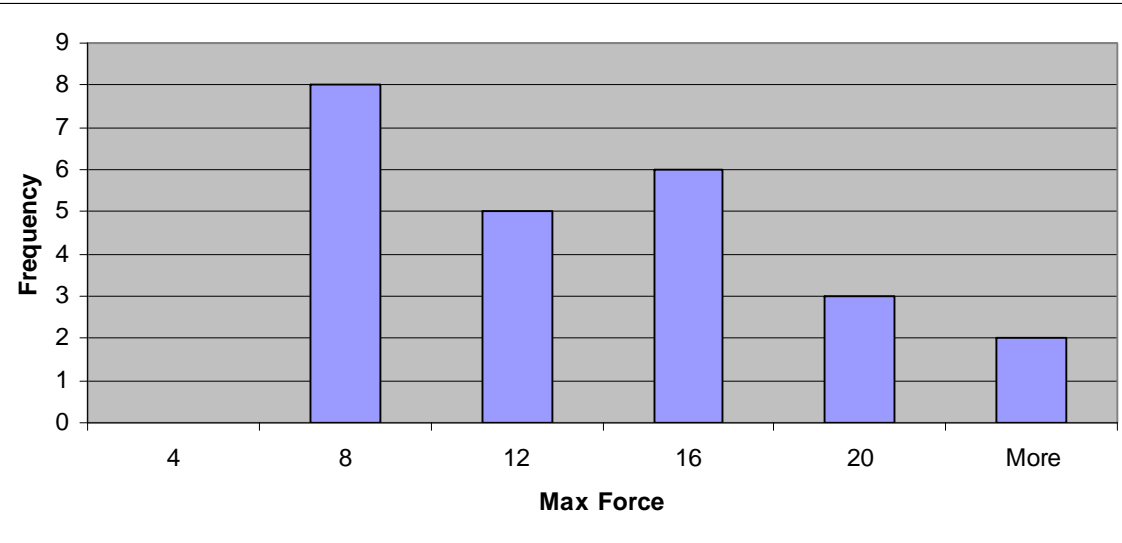
Skew: 0.6

(8 scanned areas)

**** Std. Dev. was significantly less for individual scans**

Slope Information

Force Spectroscopy Statistics SRB Prepared Surfaces



Average Force: 12.0 nN

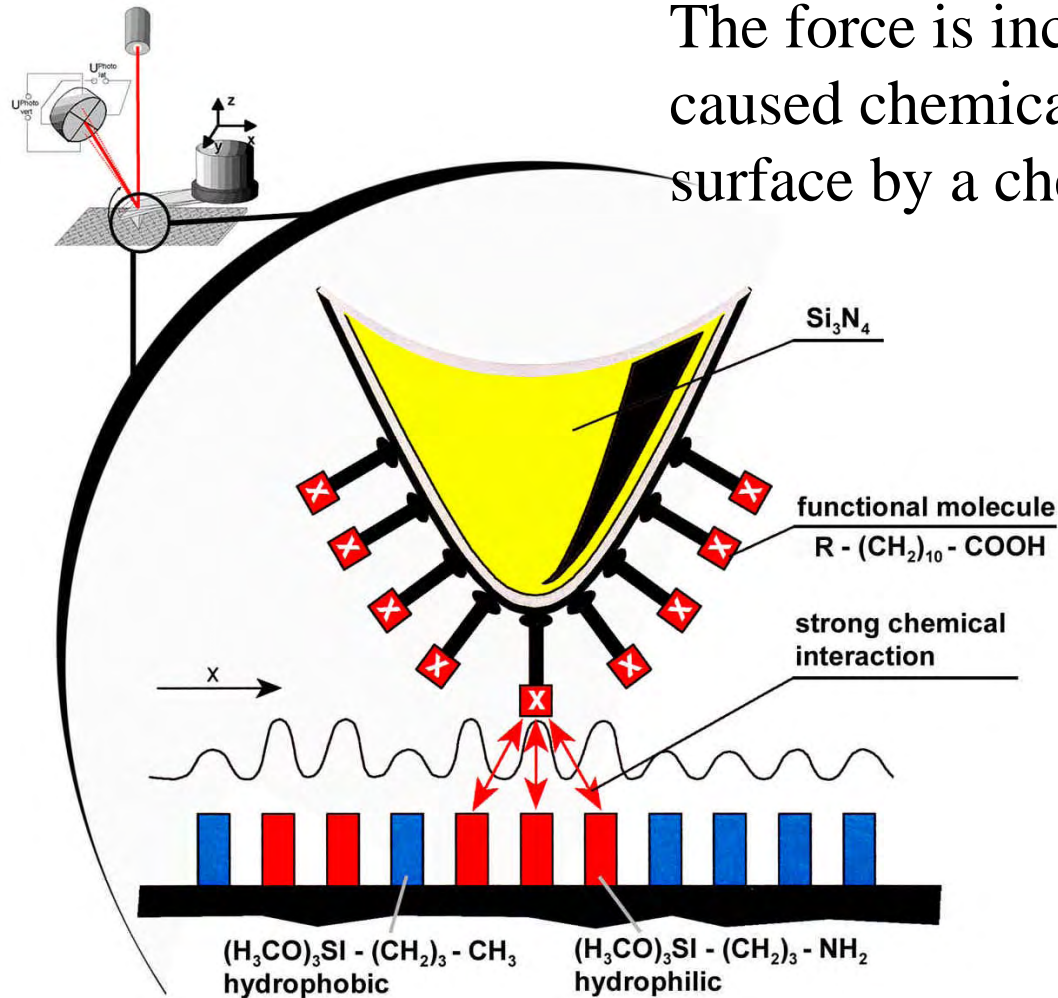
Std. Deviation: 6.8 nN**

Skew: 1.5

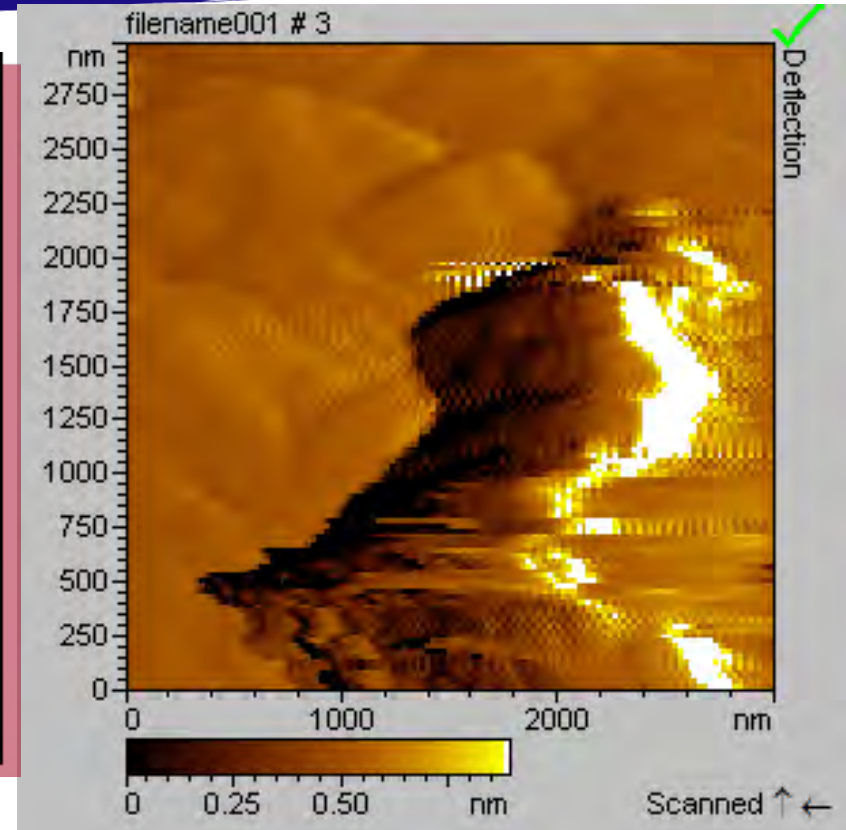
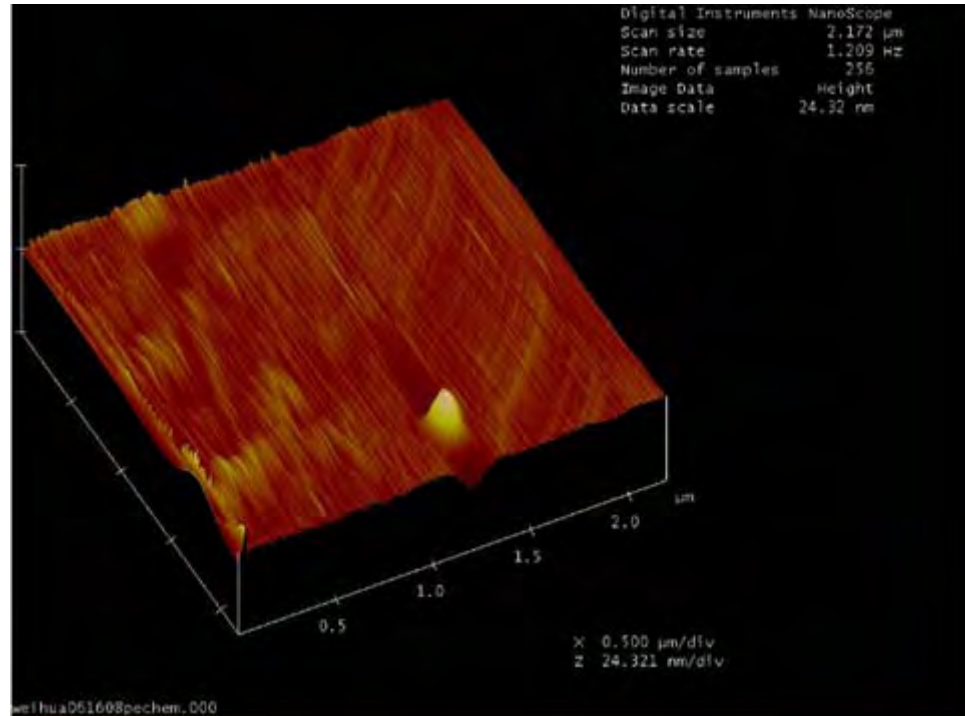
(6 scanned areas)

**** Std. Dev. was significantly less for individual scans**

Slope Information



The force is increased by the locally caused chemical reaction to the surface by a chemical component



- 3-D topographic Image
- PE prepared surface
- Hydroxyl group modified probe
- Deflection Image
- SRB prepared surface
- Hydroxyl group modified probe

- Solid-state electrochemical sensor can detect contamination on peel ply surfaces and is a promising technology for in-field surface chemistry analysis.
- In addition to Ag(I)/Ag(II), both Mn(II)/Mn(III) and Cu(I)/Cu(II) are effective mediators for electrochemical sensors.
- In addition to cyclic voltametry, electrochemical impedance spectroscopy can be a good method for surface inspection.

- AFM force spectroscopy can evaluate adhesion of the surfaces prepared with peel plies. The maximum adhesion of laminate surfaces prepared with PE peel plies is greater than that of the surface prepared with SRB peel ply, correlating with bond strength and contamination level.
- CFM images in combination with force spectroscopy can potentially provide useful information for surface activity.

- Benefit to Aviation
 - Better understanding of the pre-bond surface preparation methods
 - Better understanding of bond strength and durability versus surface preparation
 - Practical in-field, online certification and assurance technology for surface preparation
 - Reduced costs for surface preparation and adhesive bonding processes
- Future needs
 - In-field, online analytical detection and monitoring technologies for manufacture, chemical, environmental, and energy industries.
- Path
 - Continue Candidate sensor evaluation – 1. Voltametry, 2. Impedance (Conductance)
 - Sensor prototype assessment and evaluation
 - XPS/FTIR verification
 - Continue AFM/CFM series experimentation - alternate modes.